

## **PCB REQUIREMENTS – LED CONTROLLER (REV A)**

### **1. MCU / Wireless**

MCU shall be ESP32-C6. The design must support Wi-Fi 6 (2.4 GHz) and Bluetooth Low Energy (BLE). A certified ESP32-C6 module (e.g. WROOM / MINI) shall be used to simplify RF design and regulatory compliance. Proper decoupling and RF keep-out areas shall follow Espressif reference designs.

### **2. Power Supply (on the same PCB)**

An AC/DC power supply shall be integrated on the main PCB (no external PSU). Input: 230 VAC. Output: 24 V DC sized for LED load requirements. Additional rails: 5 V and 3.3 V derived via buck or equivalent. Clear primary/secondary isolation, creepage and clearance shall be respected. Test points shall be provided for 24V, 5V, 3.3V and GND.

### **3. Inputs**

#### **3.1 230 VAC Button Input**

One 230 VAC button input via screw terminal. The input shall be galvanically isolated using an optocoupler. The optocoupler output shall connect to an ESP32 GPIO, active LOW.

#### **3.2 Low-Voltage Button Input**

One low-voltage button input via screw terminal (Signal + GND). The button shall connect GPIO to GND, active LOW using internal pull-up.

### **4. LED Outputs**

Two independent LED outputs, each with its own ESP32 GPIO.

Each output shall be provided via a 3-pin screw terminal: +24V, DATA, GND. Data signals shall be level shifted to 5V logic. Series resistors (~330 Ohm) shall be placed close to the driver. Adequate decoupling and optional ESD protection shall be included.

### **5. Future Expansion – Microphone Connector**

The PCB shall include an unpopulated footprint for a small board-to-wire connector to support a future external digital microphone. The connector shall expose 3.3V, GND and reserved ESP32-C6 GPIOs suitable for digital audio (PDM preferred, I2S acceptable). No microphone shall be populated in the initial revision.

### **6. Programming & Debug**

Programming pads shall be provided for 3.3V, GND, EN, IO0 and UART TX/RX. Pads shall be accessible for pogo-pin programming.

### **7. General PCB Requirements**

Clear separation between high-voltage (230 VAC) and low-voltage circuitry. All external connections shall use screw terminals. PCB layout shall prioritize robustness, EMC performance and serviceability.

### **8. Compliance & Certification Requirements**

The product shall be designed to support CE conformity for sale within the European Union. The design shall comply with applicable EU directives, including but not limited to: Low Voltage Directive (LVD) 2014/35/EU EMC Directive 2014/30/EU Radio Equipment Directive (RED) 2014/53/EU

RoHS Directive 2011/65/EU All components shall be RoHS compliant. Where applicable, harmonized EN standards shall be followed to demonstrate conformity. Certified radio modules and power supply solutions are preferred to reduce compliance risk.